

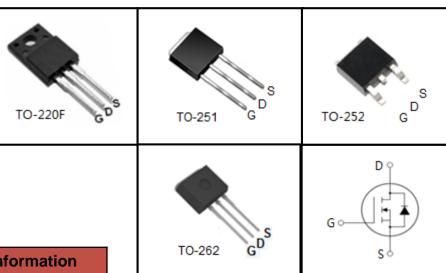
600V N-Channel MOSFET

FEATURES

- Fast switching
- Integrate fast recovery diode
- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Motor Controls
- Power Factor Correction (PFC)



Device Marking and Package Information					
Device	Package	Marking			
CSFR6N60F	TO-220F	CSFR6N60F			
CSFR6N60K	TO-262	CSFR6N60K			
CSFR6N60U	TO-251	CSFR6N60U			
CSFR6N60D	TO-252	CSFR6N60D			

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted						
Dozomotov	Symbol		11			
Parameter		TO-220F	TO262	TO-251	TO-252	Unit
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	600			V	
Continuous Drain Current	I _D	6			А	
Pulsed Drain Current (note1)	I _{DM}	24				Α
Gate-Source Voltage	V _{GSS}	±30		V		
Single Pulse Avalanche Energy (note2)	E _{AS}	88			mJ	
Avalanche Current (note1)	I _{AS}	4.2			А	
Repetitive Avalanche Energy (note1)	E _{AR}	52			mJ	
Power Dissipation (T _C = 25°C)	P _D	54 83		W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150				°C

Thermal Resistance						
Baramatar	Symbol	Value				l lmit
Parameter		TO-220F	TO-251	TO-252	TO-220	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	2.3		1.5		12/\\
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60		K/W	



Specifications $T_J = 25^{\circ}C$, ur	less othe	rwise noted					
Parameter	Symbol	Test Conditions	Value			Unit	
r al allietei	Symbol	rest conditions	Min.	Тур.	Max.		
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	600			>	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		4.0	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_D = 3.0A$		1.7	2	Ω	
Dynamic							
Input Capacitance	C _{iss}	V - 0V		644		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$		65			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		7			
Total Gate Charge	Q_g	$V_{DD} = 480V, I_{D} = 6.0A,$ $V_{GS} = 10V$		19		nC	
Gate-Source Charge	Q_{gs}			3.5			
Gate-Drain Charge	Q_{gd}	65		11			
Turn-on Delay Time	t _{d(on)}			37			
Turn-on Rise Time	t _r	$V_{DD} = 300V, I_{D} = 6.0A,$		9		ns	
Turn-off Delay Time	t _{d(off)}	$R_G = 25 \Omega$		108			
Turn-off Fall Time	t _f			40			
Drain-Source Body Diode Character	istics						
Continuous Body Diode Current	I _s	T 0500			6	- A	
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			24		
Body Diode Voltage	V_{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 3.0\text{A}, V_{GS} = 0\text{V}$			1.4	V	
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 6.0A,$		87		ns	
Reverse Recovery Charge	Q _{rr}	di _F /dt =100A /µs		0.42		μC	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics (T_J = 25°C)

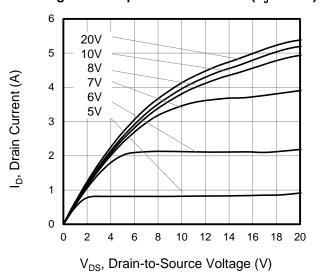


Figure 3. Drain Current vs. Temperature

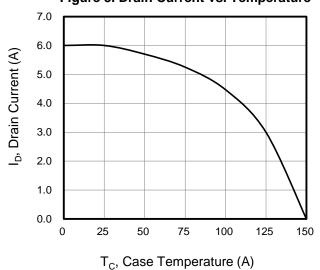


Figure 5. Transfer Characteristics

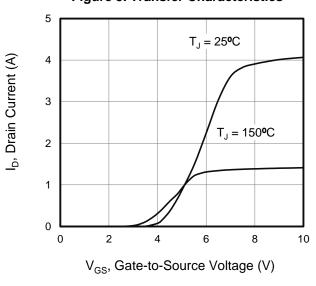


Figure 2. Body Diode Forward Voltage

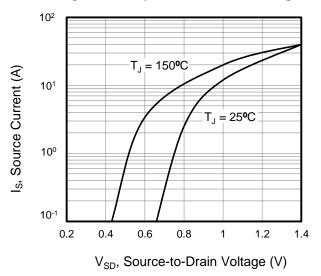


Figure 4. BV_{DSS} Variation vs. Temperature

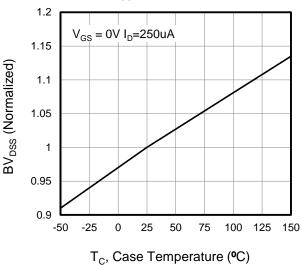
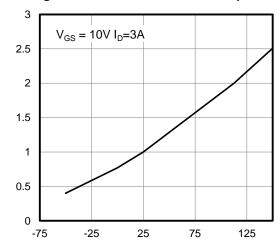


Figure 6. On-Resistance vs. Temperature



T_J, Junction Temperature (°C)

R_{DS(on)}, On-Resistance (Normalized)



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

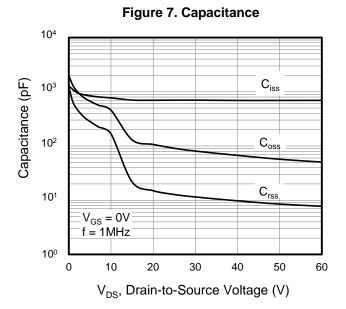


Figure 9. Transient Thermal Impedance TO-262,TO-251,TO-252

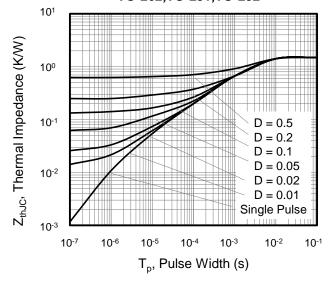


Figure 8. Gate Charge

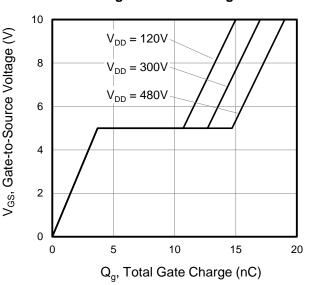


Figure 10. Transient Thermal Impedance

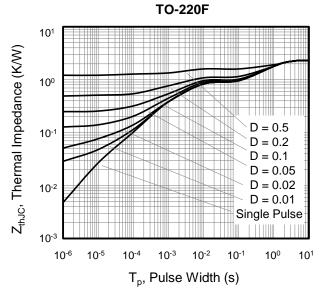




Figure A: Gate Charge Test Circuit and Waveform

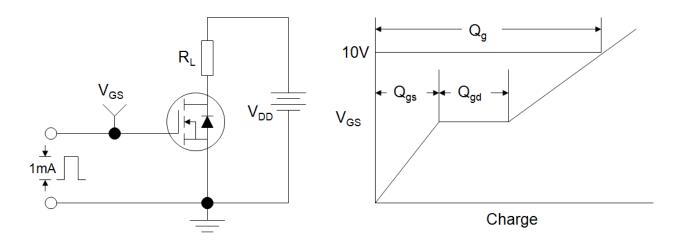


Figure B: Resistive Switching Test Circuit and Waveform

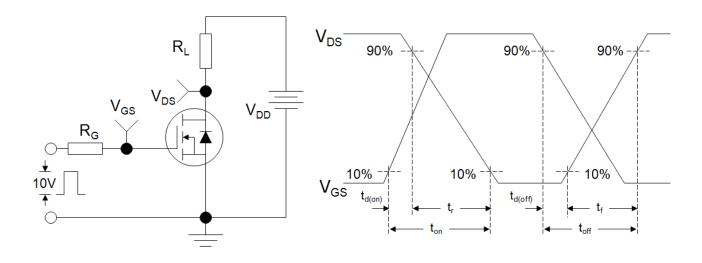
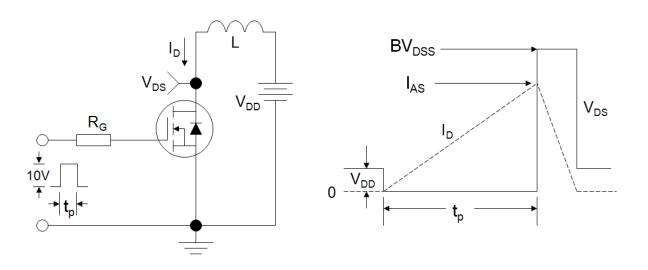
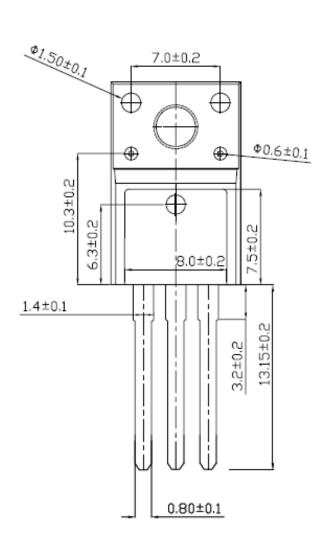


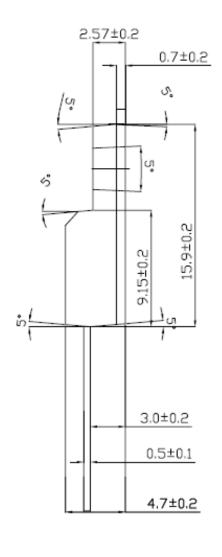
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





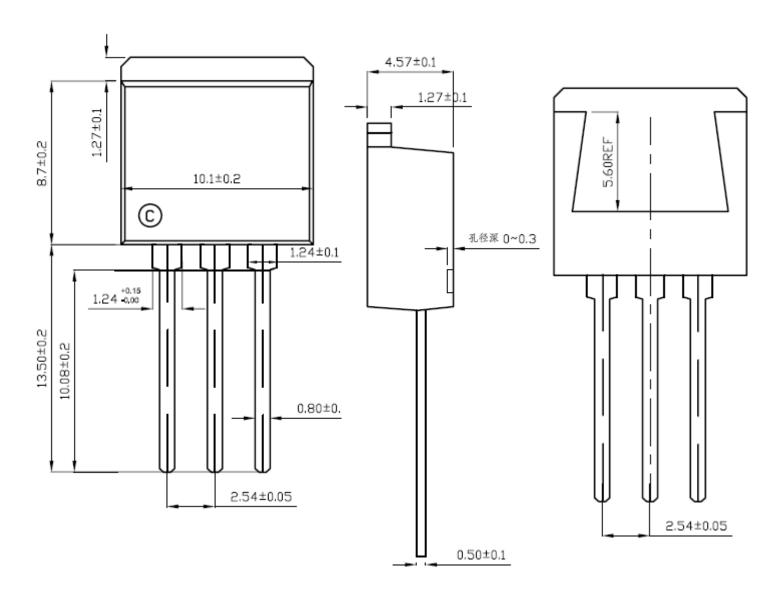
TO-220F





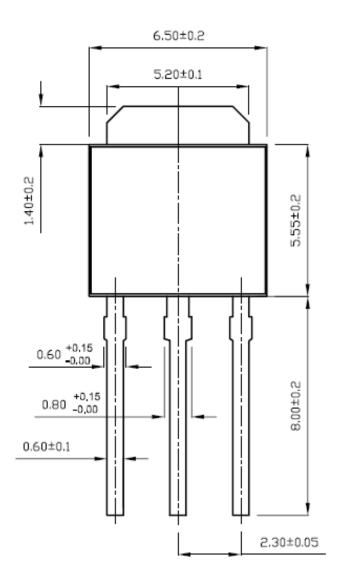


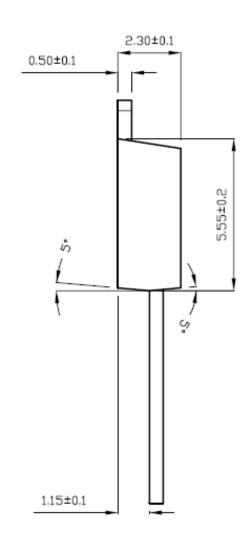
TO-262





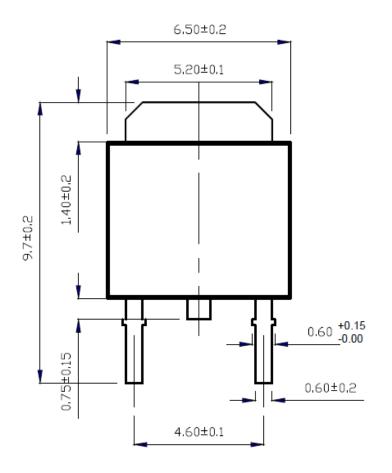
TO-251

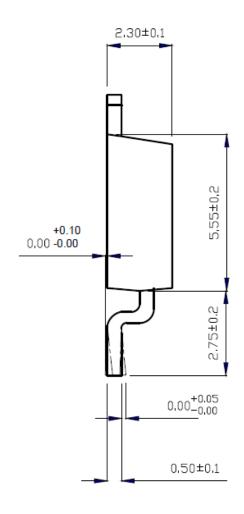






TO-252







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All product specifications and data are subject to change without notice.

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